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Dear Readers:

It is a great pleasure for me to announce the collaboration between Cloud Publications (Noida, NCR Delhi, India) and the Healthcare Packaging Consortium (Memphis, Tennessee, USA) in designating the *International Journal of Advanced Packaging Technology* as the official journal of the consortium. Our combined effort will result in a valuable resource to packaging researchers, professionals, and students worldwide. The goal of the Healthcare Packaging Consortium is to advance packaging knowledge, which aligns well with Cloud Publications' quest for knowledge. Together we can make packaging knowledge available, free of charge, to all through the open-access concept.

Volume 1 of the journal features research work performed at the consortium since its establishment in 2010. Some articles are previously unpublished original work; some are updated versions of previously published work; and some are reprints of previously published work. I would like to thank Christian Brothers University and the Institute of Packaging Professionals for allowing us to use previously published work from the *Proceedings of the MAESC 2012 Conference*, *Proceedings of the 2012 HPC Fall Meeting*, and *IoPP Journal of Packaging*. The use of previously published work is noted clearly in each article.

I am grateful to the Editorial Board members, who share a common goal with us in creating a valuable resource to the worldwide packaging community. In particular, I would like to thank Dr. Rahul Airan, Managing Editor of Cloud Journals, for entrusting me to serve as Editor-in-Chief of the journal.

On behalf of the journal I would like to invite packaging researchers and professionals to share their knowledge by submitting articles for review. All packaging related topics are welcome.

Sincerely,



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